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Fairchild Semiconductor FDW2504P

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FDW2504P

Dual P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

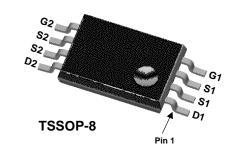
This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

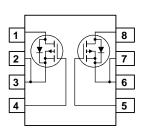
Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

Features

- -3.8 A, -20 V, $R_{DS(ON)} = 0.043 \ \Omega \ @ V_{GS} = -4.5 \ V$ $R_{DS(ON)} = 0.070 \ \Omega \ @ V_{GS} = -2.5 \ V$
- Extended V_{GSS} range (±12V) for battery applications
- Low gate charge
- High performance trench technology for extremely low R_{DS(ON)}
- Low profile TSSOP-8 package





Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±12	V
I _D	Drain Current – Continuous	(Note 1)	-3.8	A
	– Pulsed		-30	
PD	Power Dissipation	(Note 1a)	1.0	W
		(Note 1b)	0.6	
T _J , T _{STG}	Operating and Storage Junction Tempera	ture Range	-55 to +150	°C
Therma	al Characteristics			
$R_{\theta J A}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	125	°C/W
	(Note 1b)	208		

Device Marking	Device	Reel Size	Tape width	Quantity
2504P	FDW2504P	13"	12mm	2500 units

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FDW2504P Rev. E1 (W)

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-20			V
ΔBV _{DSS} ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-16		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -16 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			-1	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = -12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = 12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
On Char	acteristics (Note 2)					
/ _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.6	-1.0	-1.5	V
<u>ΔVgs(th)</u> ΔTj	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		3		mV/°
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V, I_D = -3.8 \ A \\ V_{GS} = -2.5 \ V, I_D = -3.0 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -3.8 \ A, \ T_J = 125^{\circ}C \end{array} $		0.036 0.056 0.049	0.043 0.070 0.069	Ω
D(on)	On–State Drain Current		-15			А
9 _{FS}	Forward Transconductance	$V_{\text{DS}} = -5 \text{ V}, \qquad I_{\text{D}} = -3.8 \text{ A}$		13.2		S
Dynamio	c Characteristics					
Ciss	Input Capacitance	N 40 Y 0 Y		1030		pF
Coss	Output Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		280		pF
Crss	Reverse Transfer Capacitance	1 = 1.0 10112		120		pF
Switchir	ng Characteristics (Note 2)					
d(on)	Turn–On Delay Time	$V_{DD} = -5 V$, $I_D = -1 A$,		11	20	ns
r	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		18	32	ns
d(off)	Turn-Off Delay Time			34	55	ns
f	Turn–Off Fall Time			34	55	ns
J ^g	Total Gate Charge	$V_{DS} = -5 V$, $I_D = -3.8 A$,		9.7	16	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		2.2		nC
Q _{gd}	Gate-Drain Charge			2.4		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
S	Maximum Continuous Drain-Sourc	e Diode Forward Current			-0.83	А
/ _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -0.83 A$ (Note 2)		-0.7	-1.2	V

a) $R_{\theta JA}\,is\,125~^{\circ}C/W$ (steady state) when mounted on 1 inch² copper pad on FR-4.

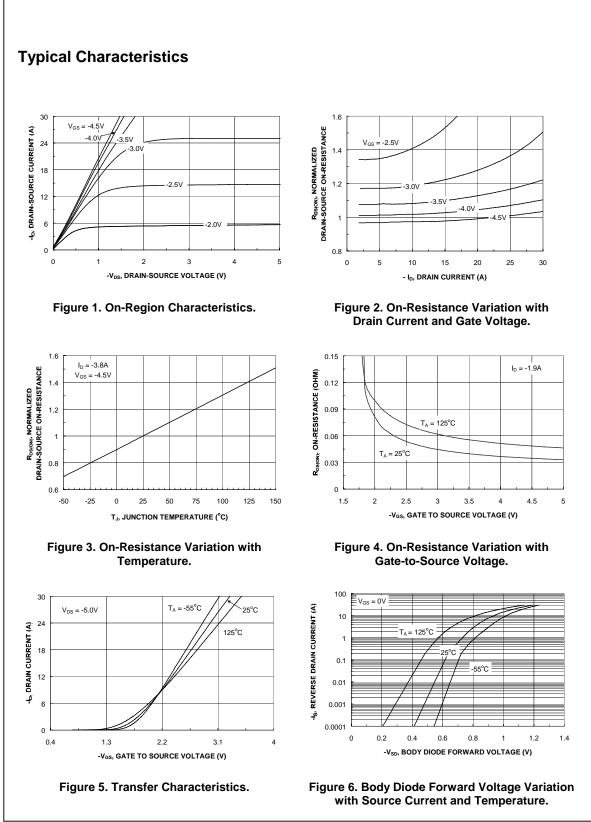
b) $~~{\rm R}_{\rm 6JA}\,$ is 208 °C/W (steady state) when mounted on minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0.

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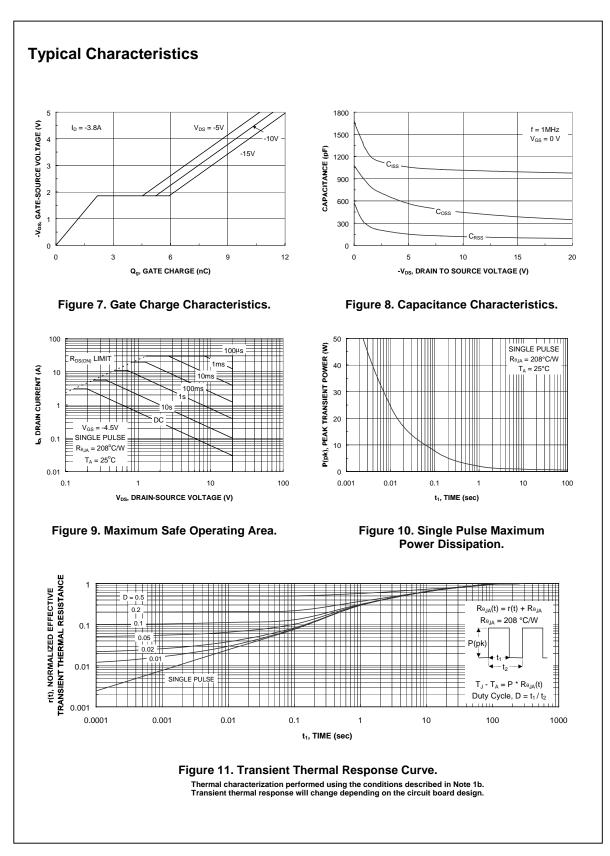




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